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[Vishay/Siliconix](#)  
[SIB419DK-T1-GE3](#)

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**New Product**

**SiB419DK**  
Vishay Siliconix

## P-Channel 12-V (D-S) MOSFET

### PRODUCT SUMMARY

V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>f, g</sup>	Q <sub>g</sub> (Typ.)
- 12	0.060 at V <sub>GS</sub> = - 4.5 V	- 9	7.15 nC
	0.082 at V <sub>GS</sub> = - 2.5 V	- 9	
	0.114 at V <sub>GS</sub> = - 1.8 V	- 2	

### FEATURES

- Halogen-free
- TrenchFET® Power MOSFET
- New Thermally Enhanced PowerPAK® SC-75 Package
- Small Footprint Area

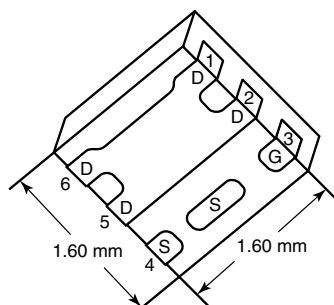


**RoHS**  
COMPLIANT

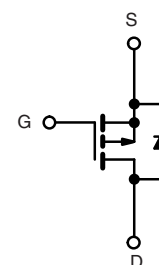
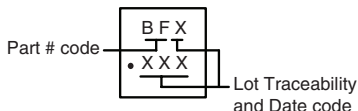
### APPLICATIONS

- Load Switch, PA Switch and Battery Switch for Portable Devices

PowerPAK SC-75-6L-Single



Marking Code



Ordering Information: SiB419DK-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS T<sub>A</sub> = 25 °C, unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	- 12	V
Gate-Source Voltage	V <sub>GS</sub>	± 8	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	I <sub>D</sub>	T <sub>C</sub> = 25 °C	- 9
		T <sub>C</sub> = 70 °C	- 9
		T <sub>A</sub> = 25 °C	- 5.2 <sup>a, b</sup>
		T <sub>A</sub> = 70 °C	- 4.2 <sup>a, b</sup>
Pulsed Drain Current	I <sub>DM</sub>	- 15	A
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	- 10.9
		T <sub>A</sub> = 25 °C	- 2.0 <sup>a, b</sup>
Maximum Power Dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C	13.1
		T <sub>C</sub> = 70 °C	8.4
		T <sub>A</sub> = 25 °C	2.45 <sup>a, b</sup>
		T <sub>A</sub> = 70 °C	1.6 <sup>a, b</sup>
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C
Soldering Recommendations (Peak Temperature) <sup>c, d</sup>		260	

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a, e</sup>	R <sub>thJA</sub>	41	51	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	7.5	9.5	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. t = 5 s.

c. See Solder Profile (<http://www.vishay.com/ppg?73257>). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

e. Maximum under Steady State conditions is 105 °C/W.

f. Based on T<sub>C</sub> = 25 °C.

g. Package Limited.

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SPECIFICATIONS T <sub>J</sub> = 25 °C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 12			V
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>	I <sub>D</sub> = - 250 μA		- 12.15		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>			5.6		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 0.4		- 1.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 8 V			± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 12 V, V <sub>GS</sub> = 0 V			- 1	μA
		V <sub>DS</sub> = - 12 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> ≤ 5 V, V <sub>GS</sub> = - 4.5 V	15			A
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5.2 A		0.049	0.060	Ω
		V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 4.4 A		0.068	0.082	
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 0.90 A		0.089	0.114	
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = - 6 V, I <sub>D</sub> = - 5.2 A		11		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = - 6 V, V <sub>GS</sub> = 0 V, f = 1 MHz		562		pF
Output Capacitance	C <sub>oss</sub>			175		
Reverse Transfer Capacitance	C <sub>rss</sub>			121		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = - 6 V, V <sub>GS</sub> = - 5 V, I <sub>D</sub> = - 5.2 A		7.88	11.82	nC
				7.15	10.73	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 9.6 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5.2 A		0.94		
Gate-Drain Charge	Q <sub>gd</sub>			1.85		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		7.5		Ω
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = - 6 V, R <sub>L</sub> = 1.46 Ω I <sub>D</sub> ≅ - 4.1 A, V <sub>GEN</sub> = - 4.5 V, R <sub>g</sub> = 1 Ω		16	24	ns
Rise Time	t <sub>r</sub>			42	63	
Turn-Off Delay Time	t <sub>d(off)</sub>			28	42	
Fall Time	t <sub>f</sub>			9	13.5	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 10.9	A
Pulse Diode Forward Current	I <sub>SM</sub>				15	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3.2 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 3.2 A, dI/dt = 100 A/μs, T <sub>J</sub> = 25 °C		26	39	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			10.4	16	nC
Reverse Recovery Fall Time	t <sub>a</sub>			14		ns
Reverse Recovery Rise Time	t <sub>b</sub>			12		

Notes:

a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

b. Guaranteed by design, not subject to production testing.

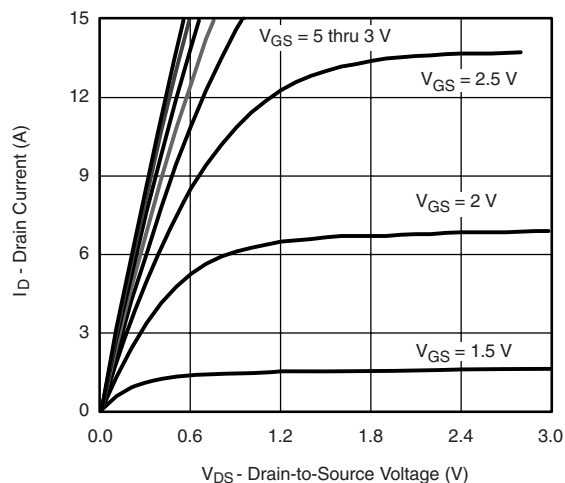
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**New Product**

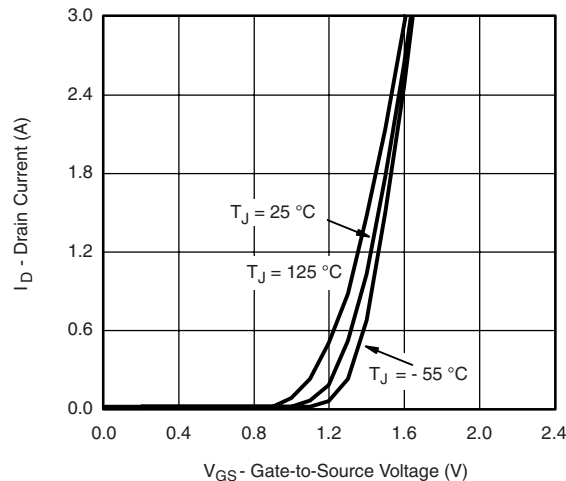


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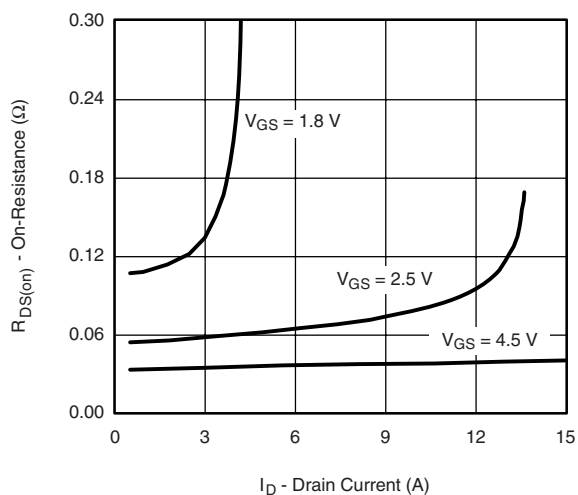
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



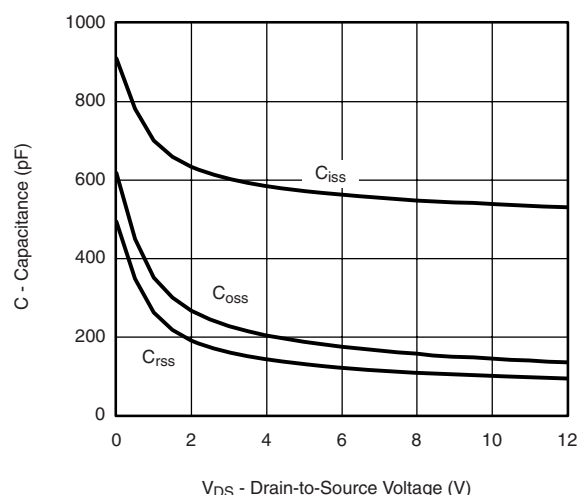
**Output Characteristics**



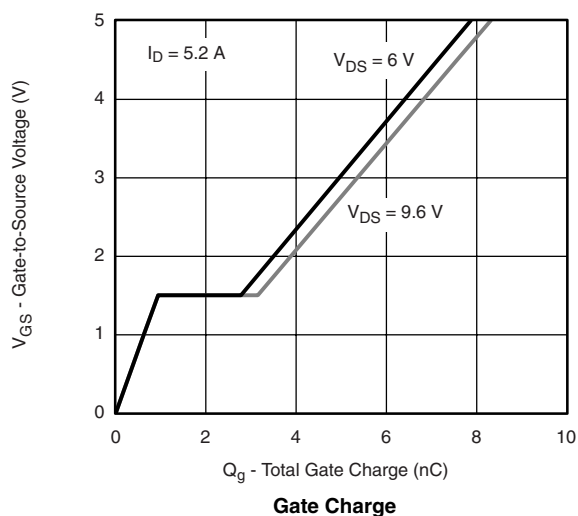
**Transfer Characteristics**



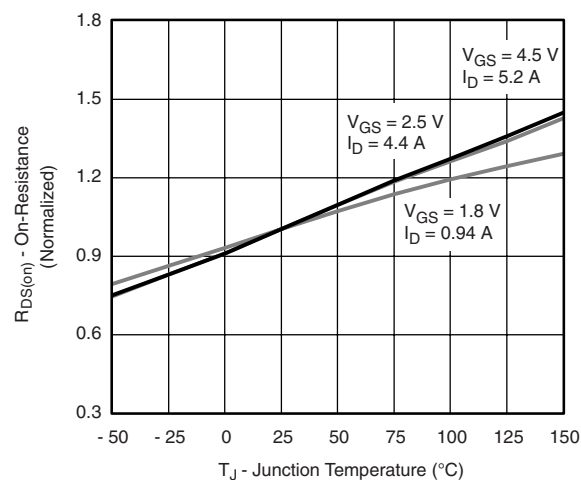
**On-Resistance vs. Drain Current and Gate Voltage**



**Capacitance**



**Gate Charge**



**On-Resistance vs. Junction Temperature**

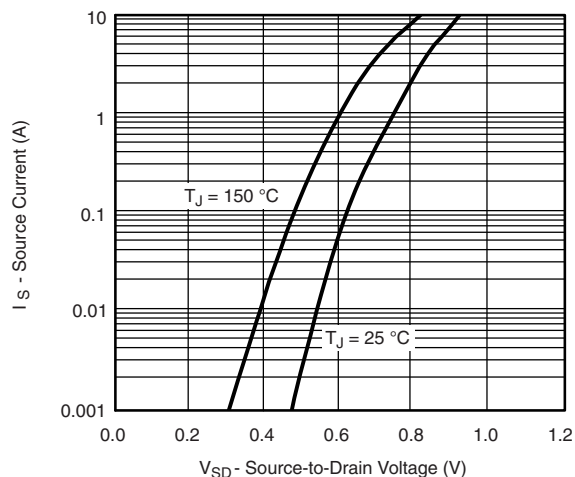
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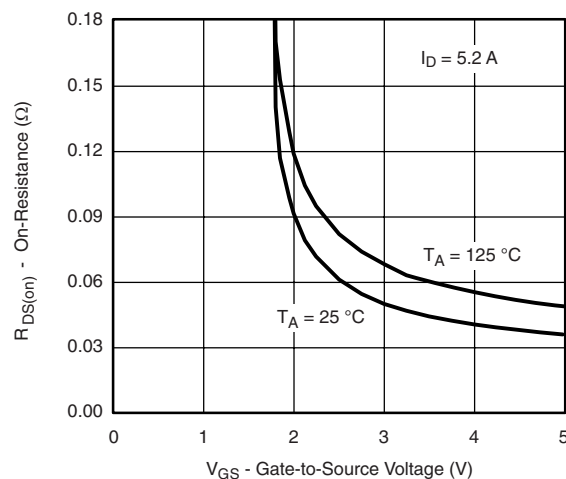
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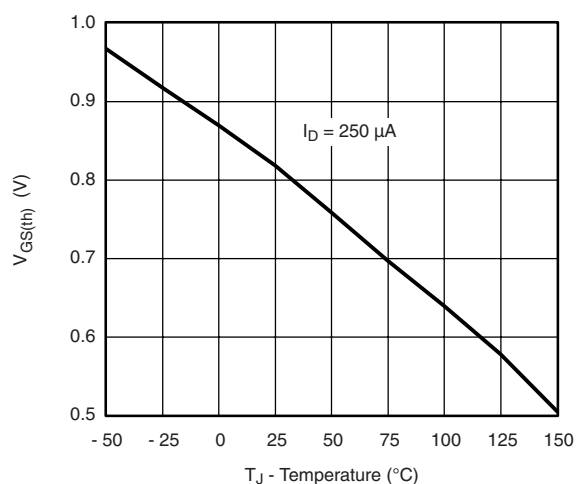
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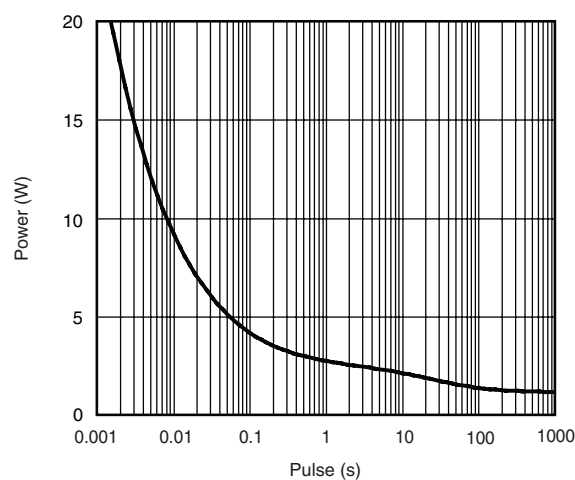
**Source-Drain Diode Forward Voltage**



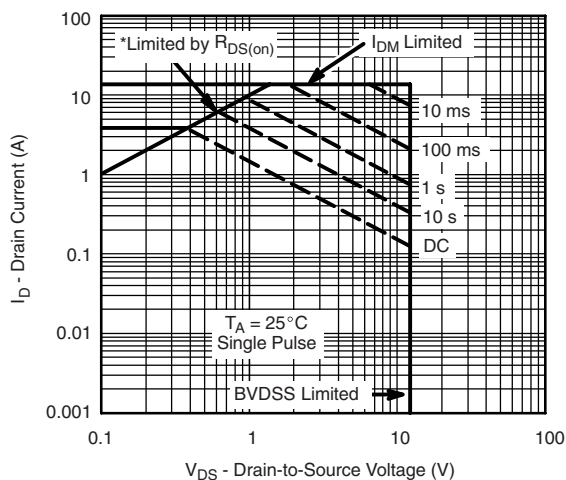
**On-Resistance vs. Gate-to-Source Voltage**



**Threshold Voltage**



**Single Pulse Power, Junction-to-Ambient**



\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

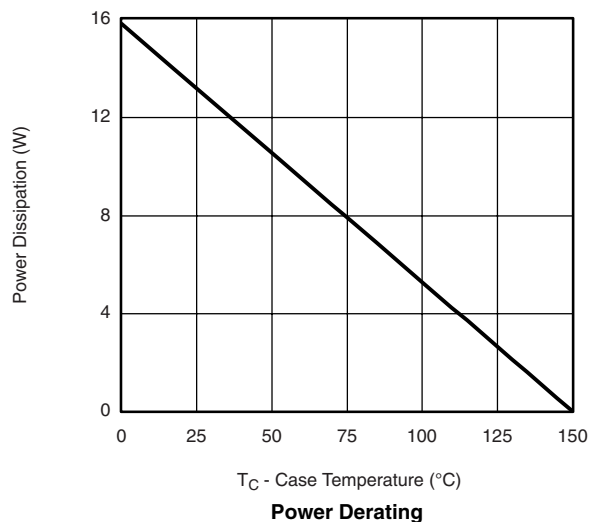
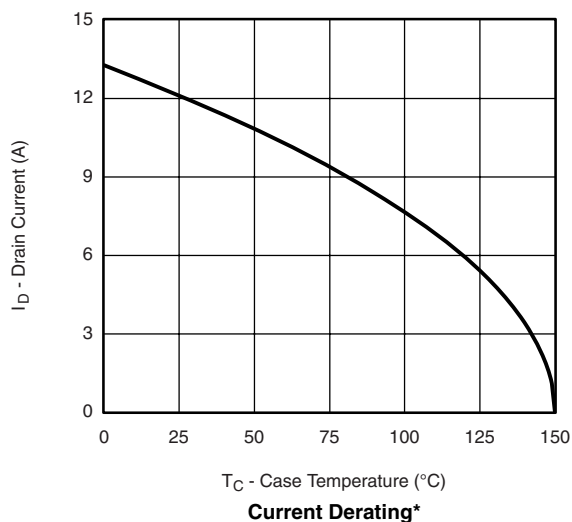
**Safe Operating Area, Junction-to-Ambient**

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**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

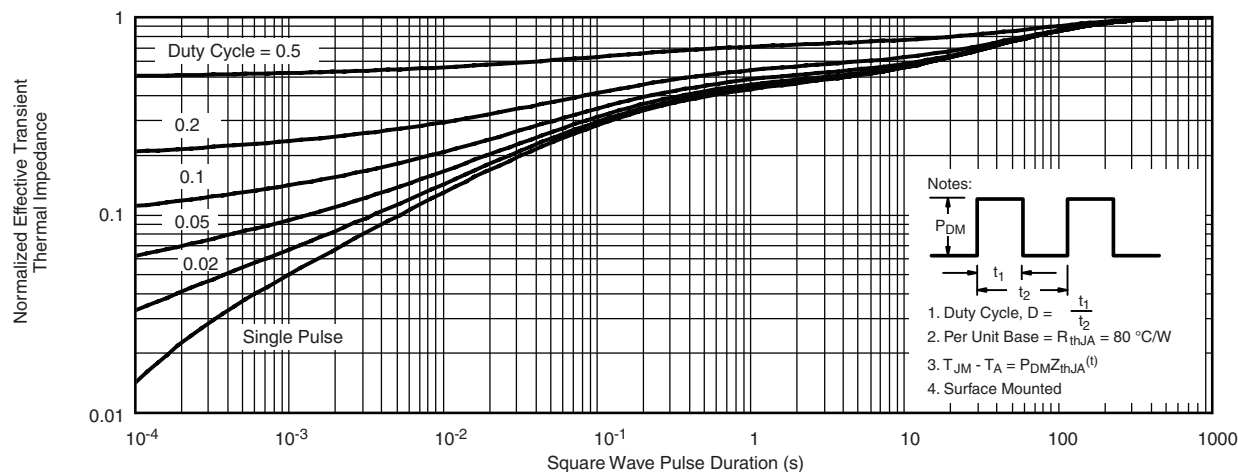
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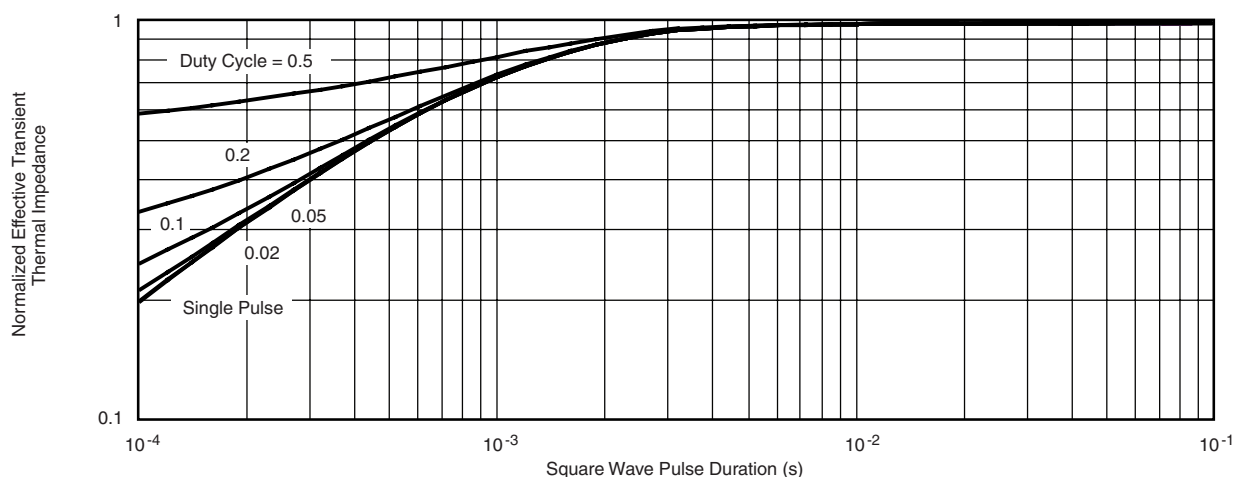
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**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Case**

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <http://www.vishay.com/ppg?70440>.



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